

3.3V LOW SKEW PLL-BASED CMOS CLOCK DRIVER (WITH 3-STATE)

IDT54/74FCT388915T 70/100/133/150 PRELIMINARY

FEATURES:

- 0.5 MICRON CMOS Technology
- Input frequency range: 10MHz f2Q Max. spec (FREQ_SEL = HIGH)
- Max. output frequency: 150MHz
- Pin and function compatible with FCT88915T, MC88915T
- 5 non-inverting outputs, one inverting output, one 2x output, one ÷2 output; all outputs are TTL-compatible
- · 3-State outputs
- Output skew < 350ps (max.)
- Duty cycle distortion < 500ps (max.)
- Part-to-part skew: 1ns (from tPD max. spec)
- 32/-16mA drive at CMOS output voltage levels
- Vcc = $3.3V \pm 0.3V$
- Inputs can be driven by 3.3V or 5V components
- Available in 28 pin PLCC, LCC and SSOP packages

DESCRIPTION:

The IDT54/74FCT388915T uses phase-lock loop technology to lock the frequency and phase of outputs to the input reference clock. It provides low skew clock distribution for high performance PCs and workstations. One of the outputs

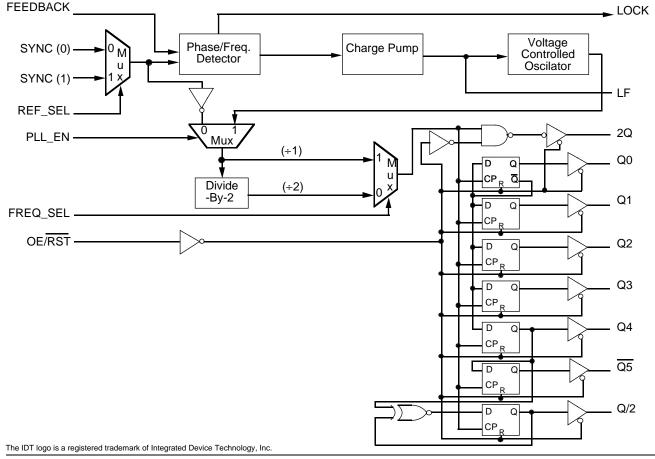
is fed back to the PLL at the FEEDBACK input resulting in essentially zero delay across the device. The PLL consists of the phase/frequency detector, charge pump, loop filter and VCO. The VCO is designed for a 2Q operating frequency range of 40MHz to f2Q Max.

The IDT54/74FCT388915T provides 8 outputs with 350ps skew. The $\overline{\text{Q5}}$ output is inverted from the Q outputs. The 2Q runs at twice the Q frequency and Q/2 runs at half the Q frequency.

The FREQ_SEL control provides an additional \div 2 option in the output path. PLL_EN allows bypassing of the PLL, which is useful in static test modes. When PLL_EN is low, SYNC input may be used as a test clock. In this test mode, the input frequency is not limited to the specified range and the polarity of outputs is complementary to that in normal operation (PLL_EN = 1). The LOCK output attains logic HIGH when the PLL is in steady-state phase and frequency lock. When OE/RST is low, all the outputs are put in high impedance state and registers at Q, \overline{Q} and Q/2 outputs are reset.

The IDT54/74FCT388915T requires one external loop filter component as recommended in Figure 3.

FUNCTIONAL BLOCK DIAGRAM

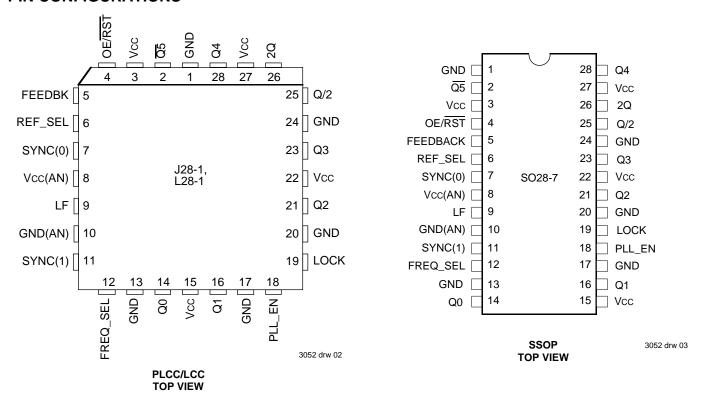


MILITARY AND COMMERCIAL TEMPERATURE RANGES

AUGUST 1995

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PIN CONFIGURATIONS



PIN DESCRIPTION

Pin Name	I/O	Description		
SYNC(0)	I	Reference clock input.		
SYNC(1)	I	Reference clock input.		
REF_SEL	I	Chooses reference between SYNC (0) & SYNC (1). (Refer to functional block diagram).		
FREQ_SEL	I	Selects between ÷ 1 and ÷ 2 frequency options. (Refer to functional block diagram).		
FEEDBACK	I	Feedback input to phase detector.		
LF	I	Input for external loop filter connection.		
Q0-Q4	0	Clock output.		
Q5	0	Inverted clock output.		
2Q	0	Clock output (2 x Q frequency).		
Q/2	0	Clock output (Q frequency ÷ 2).		
LOCK	0	Indicates phase lock has been achieved (HIGH when locked).		
OE/ RST	I	Asynchronous reset (active LOW) and output enable (active HIGH). When HIGH, outputs are enabled. When LOW, outputs are in HIGH impedance.		
PLL_EN	I	Disables phase-lock for low frequency testing. (Refer to functional block diagram).		

3052 tbl 01

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

	ADOULOTE IIII IXIIII III IXIIII III					
Symbol	Rating	Commercial	Military	Unit		
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +4.6	-0.5 to +4.6	V		
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to +7.0	-0.5 to +7.0	V		
VTERM ⁽⁴⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc +0.5	-0.5 to Vcc +0.5	V		
Та	Operating Temperature	0 to +70	-55 to +125	°C		
TBIAS	Temperature Under Bias	-55 to +125	-65 to +135	°C		
Тѕтс	Storage Temperature	-55 to +125	-65 to +150	°C		
Іоит	DC Output Current	-60 to +60	-60 to +60	mA		

CAPACITANCE (TA = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
CIN	Input	VIN = 0V	4.5	6.0	pF
	Capacitance				
Соит	Output	Vout = 0V	5.5	8.0	pF
	Capacitance				

NOTE:

3052 tbl 02

3052 lnk 03

1. This parameter is measured at characterization but not tested.

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RAT-INGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. Vcc terminals.
- 3. Input terminals.
- 4. Output and I/O terminals.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Commercial: TA = 0° C to 70° C, Vcc = 3.3V ± 0.3 V

Symbol	Parameter	Test Con	ditions ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Unit
VIH	Input HIGH Level	Guaranteed Logic HI	GH Level	2.0	_	5.5	V
VIL	Input LOW Level	Guaranteed Logic LO	DW Level	-0.5	_	0.8	V
lih	Input HIGH Current	Vcc = Max.	VI = 5.5V	_	_	±1	μΑ
lıL	Input LOW Current		Vı = GND	_	_	±1	μΑ
lozh	High Impedance Output Current	Vcc = Max.	Vo = Vcc	_	_	±1	μΑ
lozL	(3-State Output Pins)		Vo = GND	_	_	±1	μΑ
Vıĸ	Clamp Diode Voltage	VCC = Min., IIN = -18mA		_	-0.7	-1.2	V
lodh	Output Drive Current	Vcc = Max., Vin = Vi	H or VIL, VO = 1.5V ⁽³⁾	-36	_	_	mA
IODL	Output Drive Current	Vcc = Max., Vin = Vi	H or VIL, VO = 1.5V ⁽³⁾	50	_	_	mA
Voн	Output HIGH Voltage	Vcc = Min.	Iон = −16mA	2.4 ⁽⁵⁾	3.0	_	V
Vol	Output LOW Voltage	Vcc = Min.	IOL = 32mA	_	0.3	0.5	V
Vн	Input Hysteresis			_	100	_	mV
ICCL	Quiescent Power Supply Current	Vcc = Max., Vin = GND or Vcc		_	2.0	4.0	mA
ICCH ICCZ		(Test mode)					

NOTES:

3052 tbl 04

- 1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 3.3V, +25°C ambient.
- 3. Not more than one output should be tested at one time. Duration of the test should not exceed one second.
- 4. This parameter is guaranteed but not tested.
- 5. VoH = Vcc 0.6V at rated current.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Con	ditions ⁽¹⁾	Min.	Typ.(2)	Max.	Unit
Δlcc	Quiescent Power Supply Current	Vcc = Max.	$VIN = VCC - 0.6V^{(3)}$	_	2.0	30	μΑ
	TTL Inputs HIGH	$VIN = VCC - 2.1V^{(3)}$					
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = Max.	Vin = Vcc Vin = GND	_	0.2	0.3	mA/ MHz
	Current(+)	All Outputs Open	VIN = GND				IVI□Z
CPD	Power Dissipation Capacitance	50% Duty Cycle		-	15	25	pF
Ic	Total Power Supply Current ⁽⁶⁾	Vcc = Max.		_	30	60	mA
		$PLL_EN = 1, LOCK = 1,$	FEEDBACK = Q4				
		SYNC frequency = 50MHz. All bits loaded with					
		15pF					
		Vcc = Max.		_	90	120	mA
		PLL_EN = 1, LOCK = 1, FEEDBACK = Q4					
		SYNC frequency = 50MHz. All bits loaded with					
		50Ω Thevenin terminatio	n and 20pF				
NOTES:	•			-			3052 tbl 05

NOTES:

- 1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 3.3V, +25°C ambient.
- 3. Per TTL driven input. All other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations. It is derived with Q frequency as the reference.
- 5. Values for these conditions are examples of the lcc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC

 $IC = ICC + \Delta ICC DHNT + ICCD (f) + ILOAD$

Icc = Quiescent Current (IccL, IccH and Iccz)

 Δ Icc = Power Supply Current for a TTL High Input (VIN = 3.4V)

DH = Duty Cycle for TTL Inputs High

NT = Number of TTL Inputs at DH

Icco = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

f =2Q Frequency

ILOAD = Dynamic Current due to load.

SYNC INPUT TIMING REQUIREMENTS

Symbol	Parameter	Min.	Max.	Unit
TRISE/FALL	Rise/Fall Times, SYNC inputs (0.8V to 2.0V)		3.0	ns
Frequency	Input Frequency, SYNC Inputs	10.0 ⁽¹⁾	2Q fmax	MHz
Duty Cycle	Input Duty Cycle, SYNC Inputs	25%	75%	— 2052 tbl 06

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OUTPUT FREQUENCY SPECIFICATIONS

				М	ax. ⁽²⁾		
Symbol	Parameter	Min.	70	100	133	150	Unit
f2Q	Operating frequency 2Q Output	40	70	100	133	150	MHz
fQ	Operating frequency Q0-Q4, Q5 Outputs	20	35	50	66.7	75	MHz
fQ/2	Operating frequency Q/2 Output	10	17.5	25	33.3	37.5	MHz

NOTES:

3052 tbl 07

- 1. Note 7 in "General AC Specification Notes" and Figure 3 describes this specification and its actual limits depending on the feedback connection.
- 2. Maximum operating frequency is guaranteed with the part in a phase locked condition and all outputs loaded.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Symbol	Parameter	Condition ⁽¹⁾	Min.*	Max.*	Unit
trise/fall	Rise/Fall Time	Load = 50Ω to	0.2 ⁽²⁾	1.5	ns
All Outputs	(between 0.8V and 2.0V)	Vcc/2, CL = 20pF			
tpulse width (3)	Output Pulse Width	Load = 50Ω to	0.5 tCYCLE $-0.5^{(5)}$	0.5 tcycle + $0.5^{(5)}$	ns
$Q, \overline{Q}, Q/2 \text{ outputs}^{(3)}$	Q0-Q4, Q5, Q/2, @ 1.5V	Vcc/2, $CL = 20pF$			
tpulse width	Output Pulse Width		0.5 tCYCLE $-0.7^{(5)}$	0.5 tcycle + $0.7^{(5)}$	ns
2Q Output ⁽³⁾	2Q @ 1.5V				
tPD	SYNC input to FEEDBACK delay	Load = 50Ω to	-0.5	+0.5	ns
SYNC-FEEDBACK ⁽³⁾	(measured at SYNC0 or 1 and FEEDBACK	Vcc/2, $CL = 20pF$			
	input pins)	0.1μF from LF to			
		Analog GND ⁽⁵⁾			
tskewr	Output to Output Skew	Load = 50Ω to	_	250	ps
(rising) ^(3,4)	between outputs 2Q, Q0-Q4,	Vcc/2, $CL = 20pF$			
	Q/2 (rising edges only)				
tskewf	Output to Output Skew		_	250	ps
(falling) ^(3,4)	between outputs Q0-Q4 (falling edges only)	<u> </u>			
tskewall (3,4)	Output to Output Skew		_	350	ps
	2Q, Q/2, Q0-Q4 rising, Q5 falling				
tLOCK ⁽⁶⁾	Time required to acquire		1 ⁽²⁾	10	ms
	Phase-Lock from time				
	SYNC input signal is received				
tPZH	Output Enable Time		3 ⁽²⁾	14	ns
tpzl	OE/ \overline{RST} (LOW-to-HIGH) to Q, 2Q, Q/2, \overline{Q}				
tphz	Output Disable Time		3 ⁽²⁾	14	ns
tPLZ	OE/ \overline{RST} (HIGH-to-LOW) to Q, 2Q, Q/2, \overline{Q}				

GENERAL AC SPECIFICATION NOTES:

3052 tbl 08

- * PRELIMINARY.
- 1. See test circuit and waveforms.
- 2. Minimum limits are guaranteed but not tested.
- 3. These specifications are guaranteed but not production tested.
- 4. Under equally loaded conditions, as specified under test conditions and at a fixed temperature and voltage.
- tcycle = 1/frequency at which each output (Q, Q̄, Q/2 or 2Q) is expected to run.
 With Vcc fully powered-on and an output properly connected to the FEEDBACK pin. tLock Max. is with C1 = 0.1μF, tLock Min. is with C1 = 0.01μF. (Where C1 is loop filter capacitor shown in Figure 2).

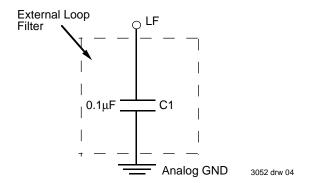
NOTES:

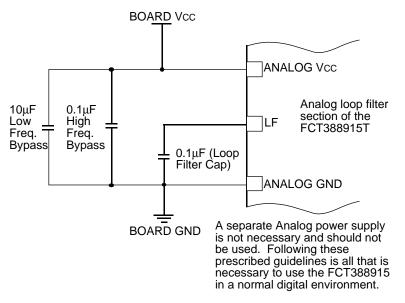
7. The wiring diagrams and written explanations of Figure 3 demonstrate the input and output frequency relationships for various possible feedback configurations. The allowable SYNC input range to stay in the phase-locked condition is also indicated. There are two allowable SYNC frequency ranges, depending on whether FREQ_SEL is HIGH or LOW. Also it is possible to feed back the Q5 output, thus creating a 180° phase shift between the SYNC input and the Q outputs. The table below summarizes the allowable SYNC frequency range for each possible configuration.

FREQ_SEL Level	Feedback Output	Allowable SYNC Input Frequency Range (MHz)	Corresponding 2Q Output Frequency Range	Phase Relationship of the Q Outputs to Rising SYNC Edge
HIGH	Q/2	10 to (2x _Q fmax Spec)/4	40 to (2Q fmax Spec)	0°
HIGH	Any Q (Q0-Q4)	20 to (2x_Q fmax Spec)/2	40 to (2Q fmax Spec)	0°
HIGH	Q5	20 to (2x_Q fmax Spec)/2	40 to (2Q fmax Spec)	180°
HIGH	2X_Q	40 to (2x_Q fmax Spec)	40 to (2Q fmax Spec)	0°
LOW	Q/2	5 to (2x_Q fmax Spec)/8	20 to (2Q fmax Spec)/2	0°
LOW	Any Q (Q0-Q4)	10 to (2x_Q fмах Spec)/4	20 to (2Q fmax Spec)/2	0°
LOW	Q5	10 to (2x_Q fмах Spec)/4	20 to (2Q fmax Spec)/2	180°
LOW	2X_Q	20 to (2x_Q fmax Spec)/2	20 to (2Q fmax Spec)/2	0°

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8. The tPD spec describes how the phase offset between the SYNC input and the output connected to the FEEDBACK input, varies with process, temperature and voltage. Measurements were made with a 10MHz SYNC input and Q/2 output as feedback. The phase measurements were made at 1.5V. The Q/2 output was terminated at the FEEDBACK input with 100Ω to VCC and 100Ω to ground. tPD measurements were made with the loop filter connection shown below:





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Figure 2. Recommended Loop Filter and Analog Isolation Scheme for the FCT388915T

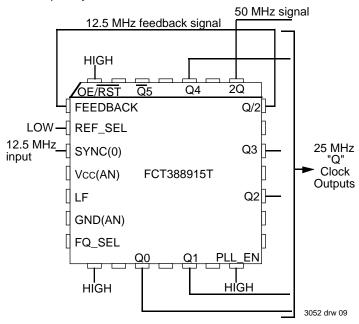
NOTES:

- 1. Figure 2 shows a loop filter and analog isolation scheme which will be effective in most applications. The following guidelines should be followed to ensure stable and jitter-free operation:
 - a. All loop filter and analog isolation components should be tied as close to the package as possible. Stray current passing through the parasitics of long traces can cause undesirable voltage transients at the LF pin.
 - b. The 10μF low frequency bypass capacitor and the 0.1μF high frequency bypass capacitor form a wide bandwidth filter that will minimize the 388915T's sensitivity to voltage transients from the system digital Vcc supply and ground planes.
 If good bypass techniques are used on a board design near components which may cause digital Vcc and ground noise, Vcc step deviations should not occur at the 388915T's digital Vcc supply. The purpose of the bypass filtering scheme shown in figure 2 is to give the 388915T additional protection from the power supply and ground plane transients that can occur in a high frequency, high speed digital system.
 - c. The loop filter capacitor (0.1µF) can be a ceramic chip capacitor, the same as a standard bypass capacitor.
- In addition to the bypass capacitors used in the analog filter of figure 2 there should be a 0.1μF bypass capacitor between each of the other (digital) four Vcc pins and the board ground plane. This will reduce output switching noise caused by the 388915T outputs, in addition to reducing potential for noise in the "analog" section of the chip. These bypass capacitors should also be tied as close to the 388915T package as possible.

The frequency relationship shown here is applicable to all Q outputs (Q0, Q1, Q2, Q3 and Q4).

1:2 INPUT TO "Q" OUTPUT FREQUENCY RELATION-SHIP

In this application, the Q/2 output is connected to the FEEDBACK input. The internal PLL will line up the positive edges of Q/2 and SYNC, thus the Q/2 frequency will equal the SYNC frequency. The Q outputs (Q0-Q4, $\overline{\rm Q5}$) will always run at 2X the Q/2 frequency, and the 2Q output will run at 4X the Q/2 frequency.

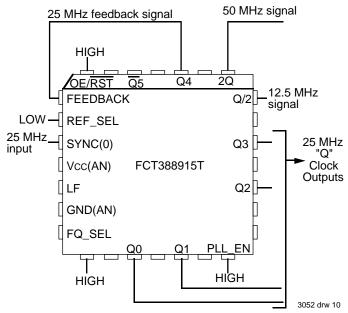


Allowable Input Frequency Range: 10MHz to (f2Q MAX Spec)/4 (for FREQ_SEL HIGH) 5MHz to (f2Q MAX Spec)/8 (for FREQ_SEL LOW)

Figure 3a. Wiring Diagram and Frequency Relationships With Q/2
Output Feedback

1:1 INPUT TO "Q" OUTPUT FREQUENCY RELATION-SHIP

In this application, the Q4 output is connected to the FEEDBACK input. The internal PLL will line up the positive edges of Q4 and SYNC, thus the Q4 frequency (and the rest of the "Q" outputs) will equal the SYNC frequency. The Q/2 output will always run at 1/2 the Q frequency, and the 2Q output will run at 2X the Q frequency.



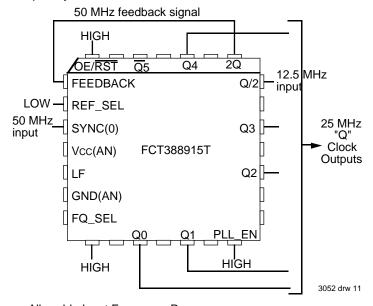
Allowable Input Frequency Range:

20MHz to (f2Q MAX Spec)/2 (for FREQ_SEL HIGH) 10MHz to (f2Q MAX Spec)/4 (for FREQ_SEL LOW)

Figure 3b. Wiring Diagram and Frequency Relationships With Q4
Output Feedback

2:1 INPUT TO "Q" OUTPUT FREQUENCY RELATION-SHIP

In this application, the 2Q output is connected to the FEEDBACK input. The internal PLL will line up the positive edges of 2Q and SYNC, thus the 2Q frequency will equal the SYNC frequency. The Q/2 output will always run at 1/4 the 2Q frequency, and the Q output will run at 1/2 the 2Q frequency.



Allowable Input Frequency Range: 40MHz to (f2Q MAX Spec) (for FREQ_SEL HIGH)

20MHz to (f2Q MAX Spec)/2 (for FREQ_SEL LOW)

Figure 3c. Wiring Diagram and Frequency Relationships With 2Q
Output Feedback

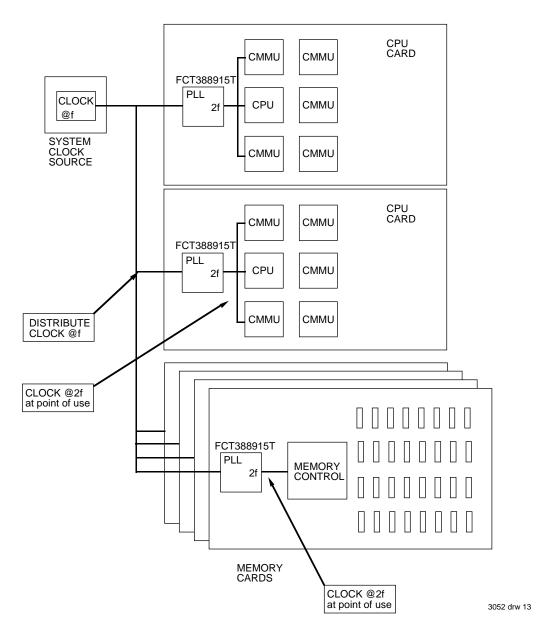


Figure 4. Multiprocessing Application Using the FCT388915T for Frequency Multiplication and Low Board-to-Board skew

FCT388915T System Level Testing Functionality

When the PLL_EN pin is LOW, the PLL is bypassed and the FCT388915T is in low frequency "test mode". In test mode (with FREQ_SEL HIGH), the 2Q output is inverted from the selected SYNC input, and the Q outputs are divide-by-2 (negative edge triggered) of the SYNC input, and the Q/2 output is divide-by-4 (negative edge triggered). With FREQ_SEL LOW the 2Q output is divide-by-2 of the SYNC, the Q outputs divide-by-4, and the Q/2 output divide-by-8.

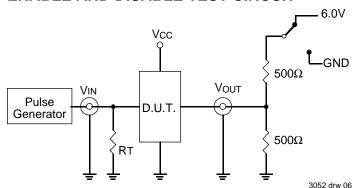
These relationships can be seen in the block diagram. A recommended test configuration would be to use SYNC0 or SYNC1 as the test clock input, and tie PLL_EN and REF_SEL together and connect them to the test select logic.

This functionality is needed since most board-level testers run at 1 MHz or below, and the FCT 388915T cannot lock onto that low of an input frequency. In the test mode described above, any test frequency test can be used.

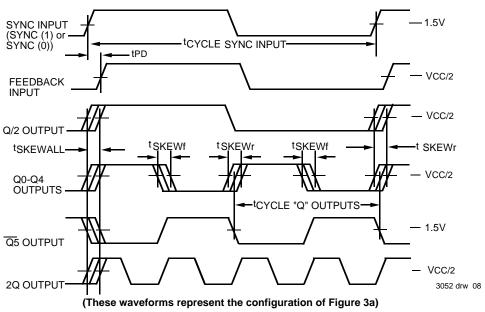
TEST CIRCUITS AND WAVEFORMS

50Ω TO Vcc/2, CL = 20PF

ENABLE AND DISABLE TEST CIRCUIT



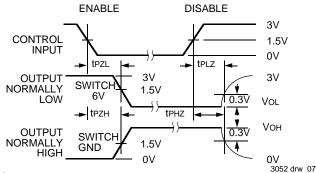
PROPAGATION DELAY, OUTPUT SKEW



NOTES:

- 1. The FCT388915T aligns rising edges of the FEEDBACK input and SYNC input, therefore the SYNC input does not require a 50% duty cycle.
- 2. All skew specs are measured between the Vcc/2 crossing point of the appropriate output edges. All skews are specified as "windows", not as ± deviation around a center point.
- 3. If a Q ouput is connected to the FEEDBACK input (this situation is not shown), the Q output frequency would match the SYNC input frequency, the 2Q output would run at twice the SYNC frequency and the Q/2 output would run at half the SYNC frequency.

ENABLE AND DISABLE TIMES



Test	Switch
Disable Low	6V
Enable Low	
Disable High	GND
Enable High	

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DEFINITIONS:

SWITCH POSITION

CL= Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to Zout of the Pulse Generator.

NOTES:

- Diagram shown for input Control Enable-LOW and input Control Disable-HIGH
- 2. Pulse Generator for All Pulses: tF ≤ 2.5ns; tR ≤ 2.5ns

ORDERING INFORMATION

